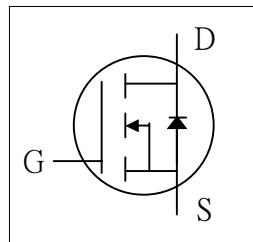
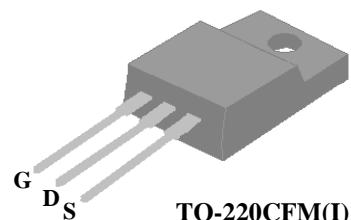




- ▼ 100% Avalanche Test
- ▼ Fast Switching Characteristic
- ▼ Simple Drive Requirement
- ▼ RoHS Compliant & Halogen-Free



| | |
|--------------|------|
| BV_{DSS} | 700V |
| $R_{DS(ON)}$ | 2.4Ω |
| I_D^4 | 4A |



Description

AP04N70B series are from Advanced Power innovative design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

The TO-220CFM package is widely preferred for all commercial-industrial through hole applications. The mold compound provides a high isolation voltage capability and low thermal resistance between the tab and the external heat-sink.

Absolute Maximum Ratings@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

| Symbol | Parameter | Rating | Units |
|---------------------------------|--|------------|---------------------|
| V_{DS} | Drain-Source Voltage | 700 | V |
| V_{GS} | Gate-Source Voltage | ± 30 | V |
| $I_D @ T_c = 25^\circ\text{C}$ | Drain Current, $V_{GS} @ 10\text{V}^4$ | 4 | A |
| $I_D @ T_c = 100^\circ\text{C}$ | Drain Current, $V_{GS} @ 10\text{V}^4$ | 2.5 | A |
| I_{DM} | Pulsed Drain Current ¹ | 15 | A |
| $P_D @ T_c = 25^\circ\text{C}$ | Total Power Dissipation | 33 | W |
| | Linear Derating Factor | 0.26 | W/ $^\circ\text{C}$ |
| E_{AS} | Single Pulse Avalanche Energy ² | 8 | mJ |
| I_{AR} | Avalanche Current | 4 | A |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^\circ\text{C}$ |
| T_j | Operating Junction Temperature Range | -55 to 150 | $^\circ\text{C}$ |

Thermal Data

| Symbol | Parameter | Value | Units |
|-------------|--|-------|---------------------------|
| R_{thj-c} | Maximum Thermal Resistance, Junction-case | 3.8 | $^\circ\text{C}/\text{W}$ |
| R_{thj-a} | Maximum Thermal Resistance, Junction-ambient | 65 | $^\circ\text{C}/\text{W}$ |



Electrical Characteristics @ $T_j=25^\circ\text{C}$ (unless otherwise specified)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|--|--|--|------|------|------|---------------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}}=0\text{V}, I_D=1\text{mA}$ | 700 | - | - | V |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_j$ | Breakdown Voltage Temperature Coefficient | Reference to 25°C , $I_D=1\text{mA}$ | - | 0.6 | - | $\text{V}/^\circ\text{C}$ |
| $R_{\text{DS(ON)}}$ | Static Drain-Source On-Resistance ³ | $V_{\text{GS}}=10\text{V}, I_D=1.6\text{A}$ | - | - | 2.4 | Ω |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{\text{DS}}=V_{\text{GS}}, I_D=250\text{\mu A}$ | 2 | - | 4 | V |
| g_{fs} | Forward Transconductance | $V_{\text{DS}}=10\text{V}, I_D=2\text{A}$ | - | 2.5 | - | S |
| I_{DSS} | Drain-Source Leakage Current | $V_{\text{DS}}=600\text{V}, V_{\text{GS}}=0\text{V}$ | - | - | 10 | \mu A |
| | Drain-Source Leakage Current ($T_j=125^\circ\text{C}$) | $V_{\text{DS}}=480\text{V}, V_{\text{GS}}=0\text{V}$ | - | - | 500 | \mu A |
| I_{GSS} | Gate-Source Leakage | $V_{\text{GS}}=+30\text{V}, V_{\text{DS}}=0\text{V}$ | - | - | +100 | nA |
| Q_g | Total Gate Charge ³ | $I_D=4\text{A}$ | - | 16.7 | - | nC |
| Q_{gs} | Gate-Source Charge | $V_{\text{DS}}=480\text{V}$ | - | 4.1 | - | nC |
| Q_{gd} | Gate-Drain ("Miller") Charge | $V_{\text{GS}}=10\text{V}$ | - | 4.9 | - | nC |
| $t_{\text{d(on)}}$ | Turn-on Delay Time ³ | $V_{\text{DD}}=300\text{V}$ | - | 11 | - | ns |
| t_r | Rise Time | $I_D=4\text{A}$ | - | 8.3 | - | ns |
| $t_{\text{d(off)}}$ | Turn-off Delay Time | $R_G=10\Omega$ | - | 23.8 | - | ns |
| t_f | Fall Time | $V_{\text{GS}}=10\text{V}$ | - | 8.2 | - | ns |
| C_{iss} | Input Capacitance | $V_{\text{GS}}=0\text{V}$ | - | 950 | - | pF |
| C_{oss} | Output Capacitance | $V_{\text{DS}}=25\text{V}$ | - | 65 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | f=1.0MHz | - | 6 | - | pF |

Source-Drain Diode

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Units |
|-----------------|---|--|------|------|------|-------|
| I_s | Continuous Source Current (Body Diode) | $V_D=V_G=0\text{V}, V_S=1.5\text{V}$ | - | - | 4 | A |
| I_{SM} | Pulsed Source Current (Body Diode) ¹ | | - | - | 15 | A |
| V_{SD} | Forward On Voltage ³ | $T_j=25^\circ\text{C}, I_s=4\text{A}, V_{\text{GS}}=0\text{V}$ | - | - | 1.5 | V |

Notes:

1. Pulse width limited by max. junction temperature
2. Starting $T_j=25^\circ\text{C}$, $V_{\text{DD}}=50\text{V}$, $L=1\text{mH}$, $R_G=25\Omega$, $I_{\text{AS}}=4\text{A}$.
3. Pulse test
4. Ensure that the junction temperature does not exceed $T_{j\max}$.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

APEC DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

APEC RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN.

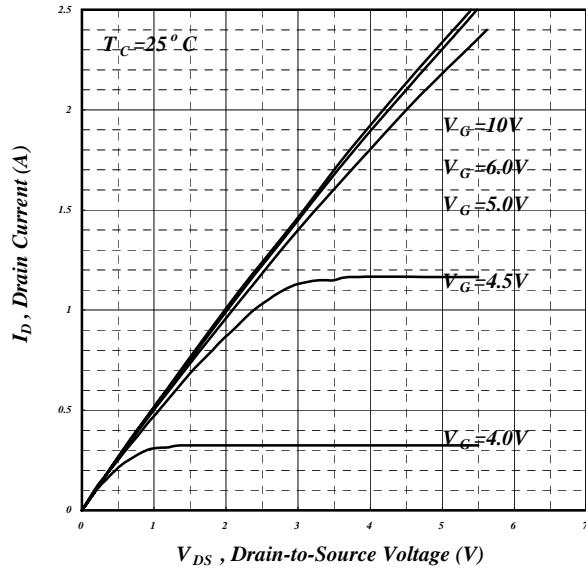


Fig 1. Typical Output Characteristics

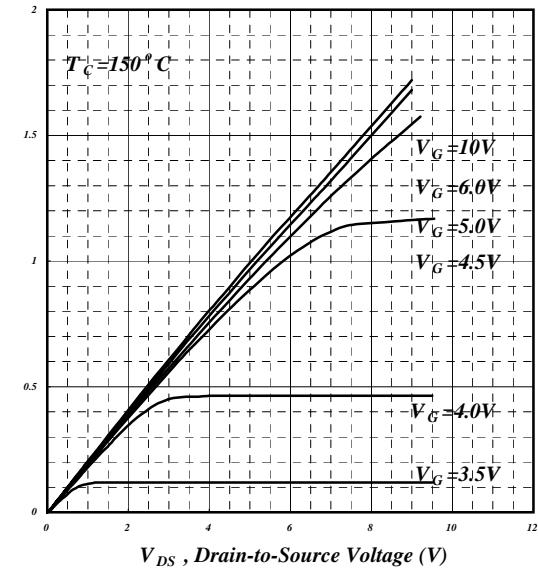


Fig 2. Typical Output Characteristics

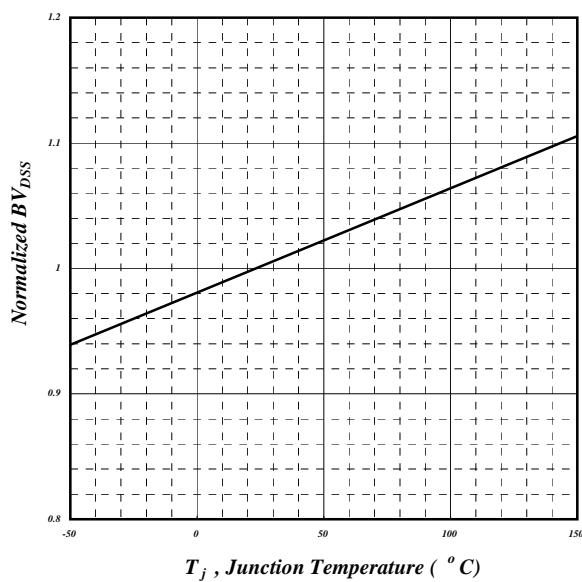
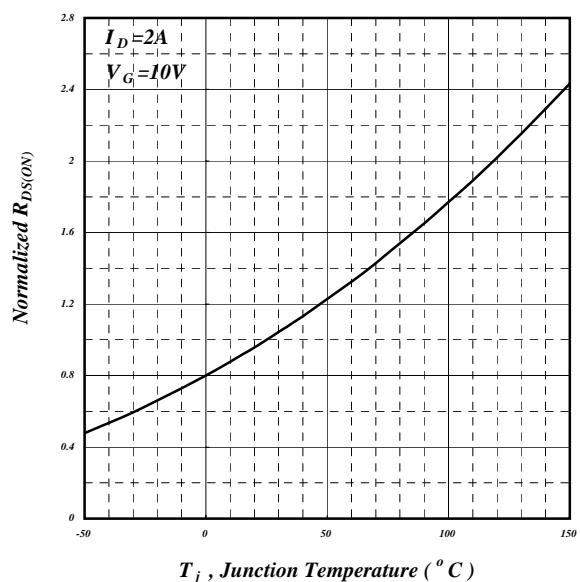
Fig 3. Normalized BV_{DSS} v.s. Junction Temperature

Fig 4. Normalized On-Resistance v.s. Junction Temperature



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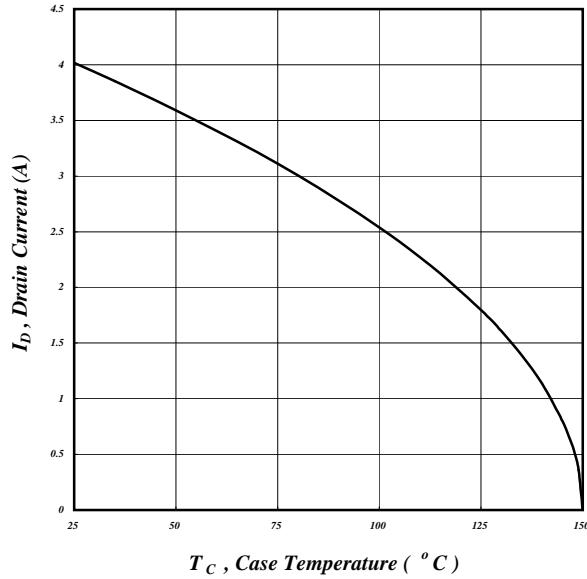


Fig 5. Maximum Drain Current v.s. Case Temperature

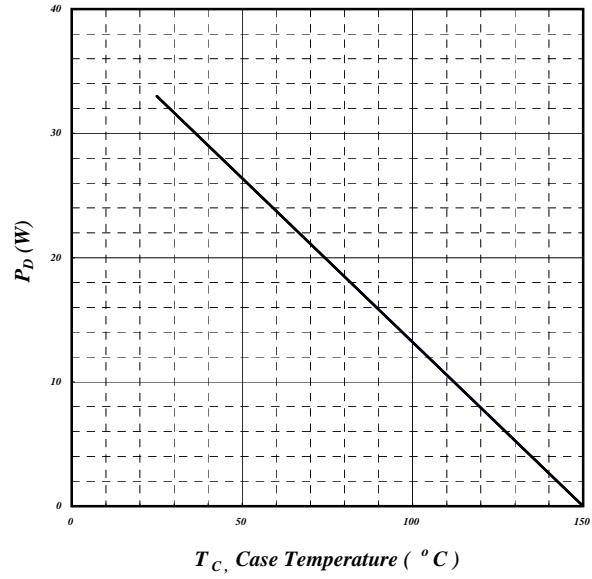


Fig 6. Typical Power Dissipation

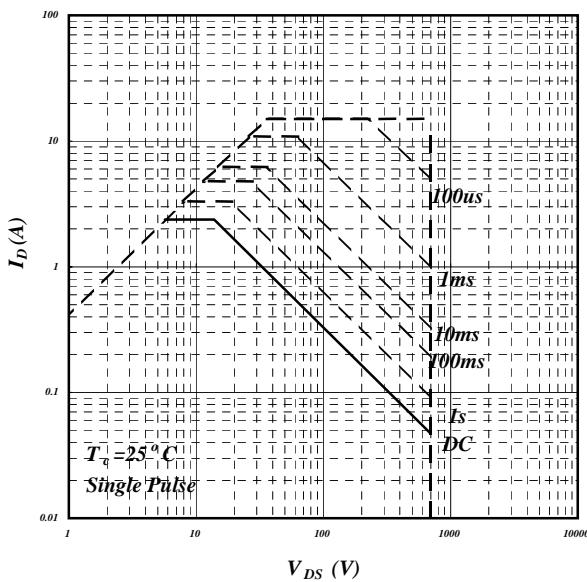


Fig 7. Maximum Safe Operating Area

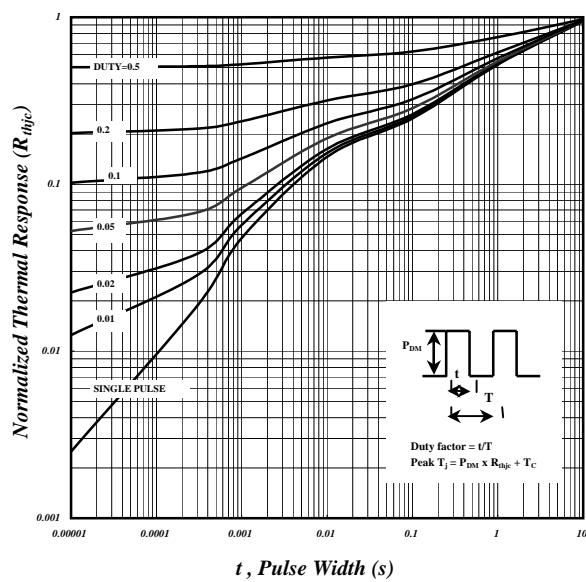


Fig 8. Effective Transient Thermal Impedance

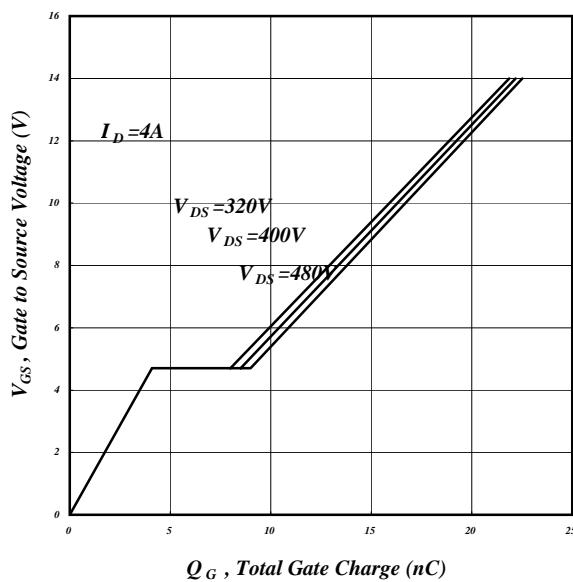


Fig 9. Gate Charge Characteristics

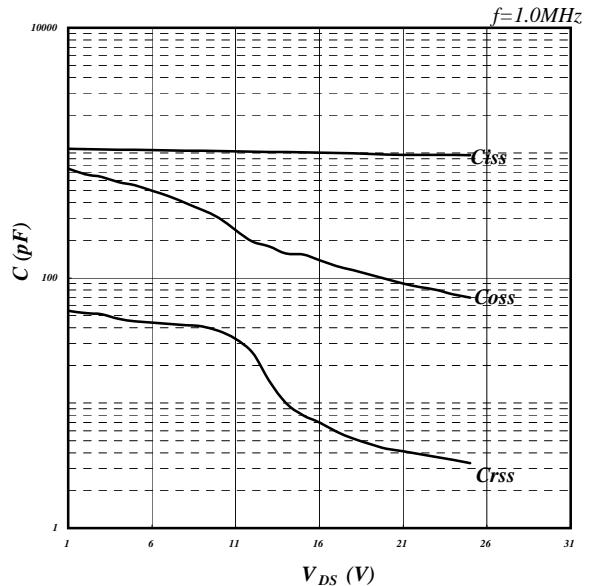


Fig 10. Typical Capacitance Characteristics

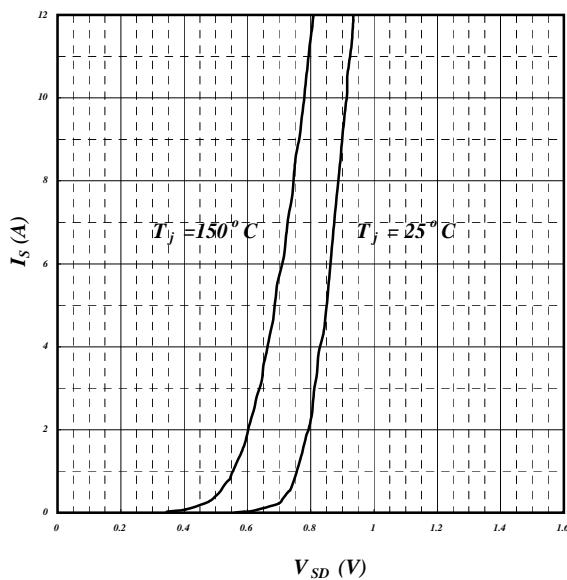


Fig 11. Forward Characteristic of Reverse Diode

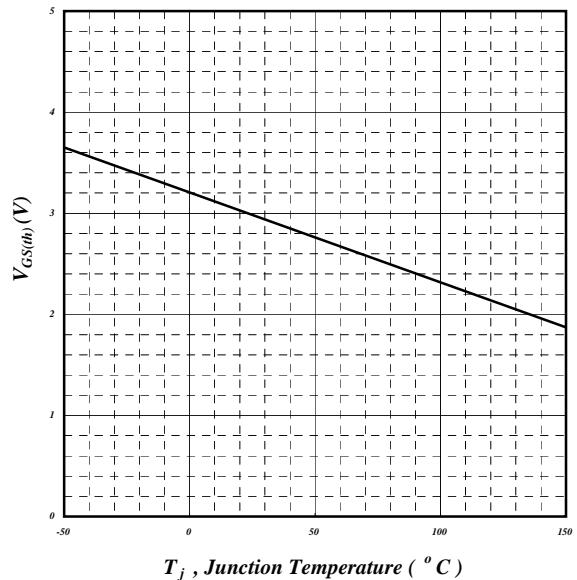


Fig 12. Gate Threshold Voltage v.s. Junction Temperature



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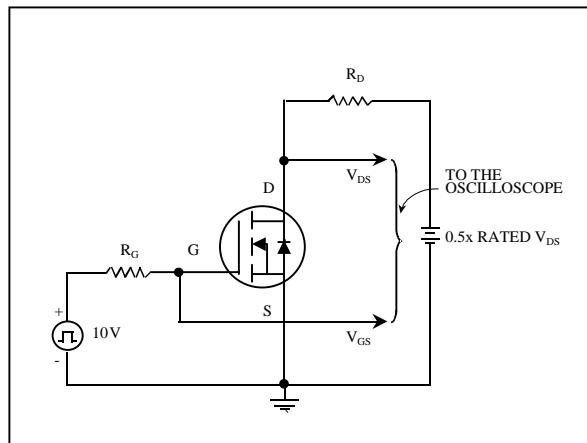


Fig 13. Switching Time Circuit

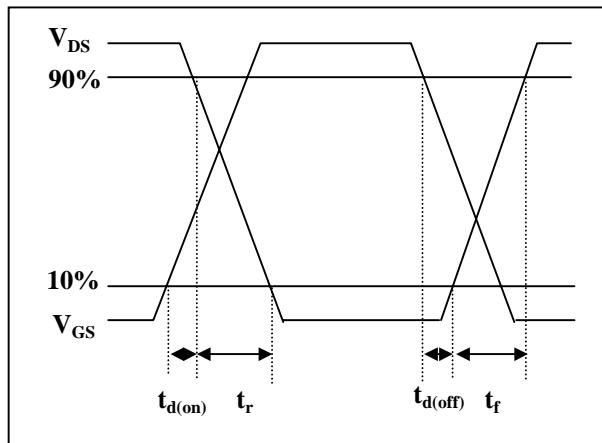


Fig 14. Switching Time Waveform

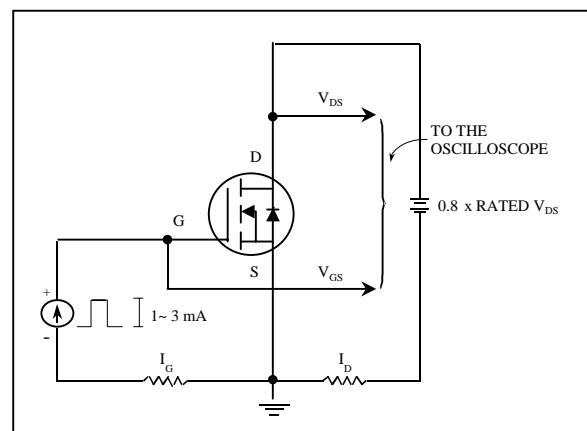


Fig 15. Gate Charge Circuit

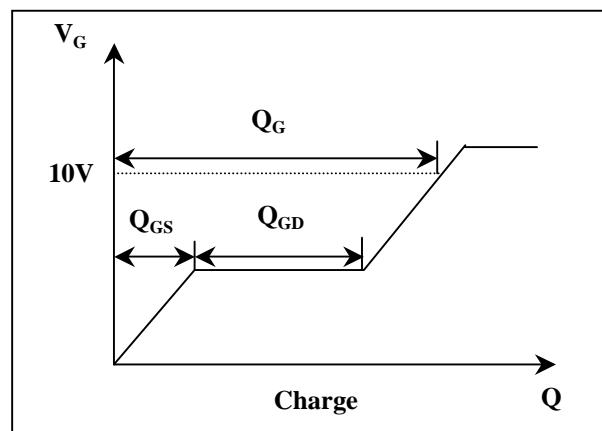


Fig 16. Gate Charge Waveform



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MARKING INFORMATION

